# Dual N-Channel 20-V (D-S) MOSFET

| PRODUCT SUMMARY | | | |
|---|---|---|---|
| $V_{DS}$ (V) | $r_{DS(on)}$ (Ω) | $I_D$ (A)[a] | $Q_g$ (Typ) |
| 20 | 0.168 at $V_{GS}$ = 4.5 V | 1.3[a] | 1.6 nC |
| | 0.200 at $V_{GS}$ = 2.5 V | 1.3[a] | |
| | 0.250 at $V_{GS}$ = 1.8 V | 1.3[a] | |

## FEATURES

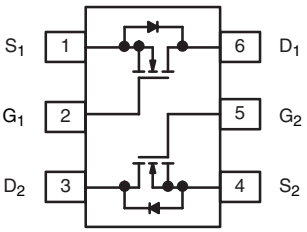
- TrenchFET® Power MOSFET

## APPLICATIONS

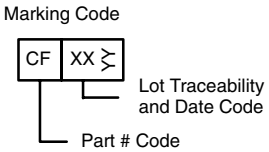
- Load Switch for Portable Applications

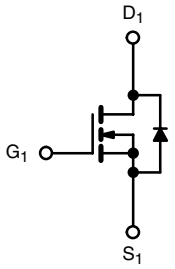
Pb-free
RoHS COMPLIANT

**SOT-363**
**SC-70 (6-LEADS)**

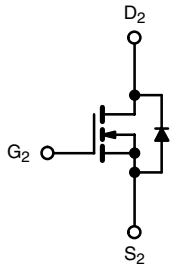



Top View




N-Channel MOSFET




N-Channel MOSFET

**Ordering Information:** Si1988DH-T1-E3 (Lead (Pb)-free)

| ABSOLUTE MAXIMUM RATINGS $T_A$ = 25 °C, unless otherwise noted | | | | |
|---|---|---|---|---|
| **Parameter** | | **Symbol** | **Limit** | **Unit** |
| Drain-Source Voltage | | $V_{DS}$ | 20 | V |
| Gate-Source Voltage | | $V_{GS}$ | ± 8 | |
| Continuous Drain Current ($T_J$ = 150 °C) | $T_C$ = 25 °C | $I_D$ | 1.3[a] | A |
| | $T_C$ = 70 °C | | 1.3[a] | |
| | $T_A$ = 25 °C | | 1.3[a, b, c] | |
| | $T_A$ = 70 °C | | 1.3[a, b, c] | |
| Pulsed Drain Current | | $I_{DM}$ | 4 | |
| Continuous Source-Drain Diode Current | $T_C$ = 25 °C | $I_S$ | 1.0 | |
| | $T_A$ = 25 °C | | 0.61[b, c] | |
| Maximum Power Dissipation | $T_C$ = 25 °C | $P_D$ | 1.25 | W |
| | $T_C$ = 70 °C | | 0.8 | |
| | $T_A$ = 25 °C | | 0.74[b, c] | |
| | $T_A$ = 70 °C | | 0.47[b, c] | |
| Operating Junction and Storage Temperature Range | | $T_J$, $T_{stg}$ | - 55 to 150 | °C |
| Soldering Recommendations (Peak Temperature)[d, e] | | | 260 | |

| THERMAL RESISTANCE RATINGS | | | | | |
|---|---|---|---|---|---|
| **Parameter** | | **Symbol** | **Typical** | **Maximum** | **Unit** |
| Maximum Junction-to-Ambient[b, f] | t ≤ 5 sec | $R_{thJA}$ | 130 | 170 | °C/W |
| Maximum Junction-to-Foot (Drain) | Steady State | $R_{thJF}$ | 80 | 100 | |

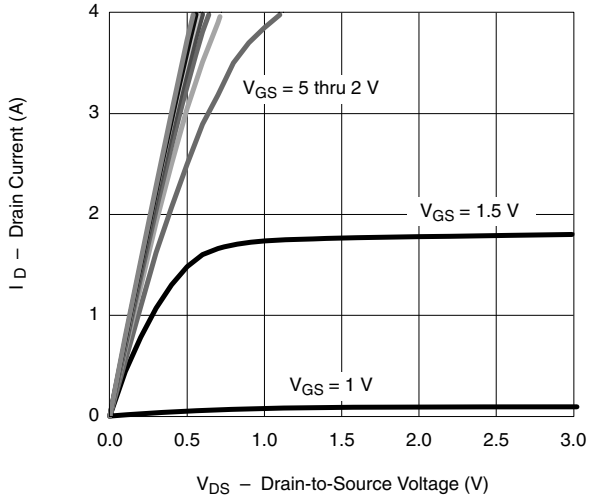
Notes:
a. Package limited.
b. Surface Mounted on 1" x 1" FR4 Board.
c. t = 5 sec.
d. Maximum under Steady State conditions is 220 °C/W.

| **SPECIFICATIONS** $T_J$ = 25 °C, unless otherwise noted | | | | | | |
|---|---|---|---|---|---|---|
| **Parameter** | **Symbol** | **Test Conditions** | **Min** | **Typ** | **Max** | **Unit** |
| **Static** | | | | | | |
| Drain-Source Breakdown Voltage | $V_{DS}$ | $V_{GS}$ = 0 V, $I_D$ = 250 µA | 20 | | | V |
| $V_{DS}$ Temperature Coefficient | $\Delta V_{DS}/T_J$ | $I_D$ = 250 µA | | 19.7 | | mV/°C |
| $V_{GS(th)}$ Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | | | - 2.4 | | |
| Gate-Source Threshold Voltage | $V_{GS(th)}$ | $V_{DS}$ = $V_{GS}$, $I_D$ = 250 µA | 0.4 | | 1 | V |
| Gate-Source Leakage | $I_{GSS}$ | $V_{DS}$ = 0 V, $V_{GS}$ = ± 8 V | | | ± 100 | ns |
| Zero Gate Voltage Drain Current | $I_{DSS}$ | $V_{DS}$ = 20 V, $V_{GS}$ = 0 V | | | 1 | µA |
| | | $V_{DS}$ = 20 V, $V_{GS}$ = 0 V, $T_J$ = 55 °C | | | 10 | |
| On-State Drain Current[a] | $I_{D(on)}$ | $V_{DS} \leq$ 5 V, $V_{GS}$ = 4.5 V | 4 | | | A |
| Drain-Source On-State Resistance[a] | $r_{DS(on)}$ | $V_{GS}$ = 4.5 V, $I_D$ = 1.4 A | | 0.139 | 0.168 | Ω |
| | | $V_{GS}$ = 2.5 V, $I_D$ = 1.3 A | | 0.165 | 0.200 | |
| | | $V_{GS}$ = 1.8 V, $I_D$ = 0.4 A | | 0.205 | 0.250 | |
| Forward Transconductance[a] | $g_{fs}$ | $V_{DS}$ = 4 V, $I_D$ = 1.4 A | | 4 | | S |
| **Dynamic[b]** | | | | | | |
| Input Capacitance | $C_{iss}$ | $V_{DS}$ = 10 V, $V_{GS}$ = 0 V, f = 1 MHz | | 110 | | pF |
| Output Capacitance | $C_{oss}$ | | | 25 | | |
| Reverse Transfer Capacitance | $C_{rss}$ | | | 11 | | |
| Total Gate Charge | $Q_g$ | $V_{DS}$ = 10 V, $V_{GS}$ = 8 V, $I_D$ = 1.6 A | | 2.7 | 4.1 | nC |
| | | $V_{DS}$ = 10 V, $V_{GS}$ = 4.5 V, $I_D$ = 1.6 A | | 1.6 | 2.4 | |
| Gate-Source Charge | $Q_{gs}$ | | | 0.3 | | |
| Gate-Drain Charge | $Q_{gd}$ | | | 0.25 | | |
| Gate Resistance | $R_g$ | f = 1 MHz | | 4 | | Ω |
| Turn-On Delay Time | $t_{d(on)}$ | $V_{DD}$ = 10 V, $R_L$ = 7.7 Ω<br>$I_D \cong$ 1.3 A, $V_{GEN}$ = 4.5 V, $R_g$ = 1 Ω | | 8 | 12 | ns |
| Rise Time | $t_r$ | | | 20 | 30 | |
| Turn-Off Delay Time | $t_{d(off)}$ | | | 15 | 25 | |
| Fall Time | $t_f$ | | | 10 | 15 | |
| Turn-on Delay Time | $t_{d(on)}$ | $V_{DD}$ = 10 V, $R_L$ = 7.7 Ω<br>$I_D \cong$ 1.3 A, $V_{GEN}$ = 8 V, $R_g$ = 1 Ω | | 5 | 10 | |
| Rise Time | tr | | | 11 | 20 | |
| Turn-Off Delay Time | $t_{d(off)}$ | | | 10 | 15 | |
| Fall Time | tr | | | 6 | 10 | |
| **Drain-Source Body Diode Characteristics** | | | | | | |
| Continuous Source-Drain Diode Current | $I_S$ | $T_C$ = 25 °C | | | 1 | A |
| Pulse Diode Forward Current | $I_{SM}$ | | | | 4 | |
| Body Diode Voltage | $V_{SD}$ | $I_S$ = 1.3 A, $V_{GS}$ = 0 V | | 0.8 | 1.2 | V |
| Body Diode Reverse Recovery Time | $t_{rr}$ | $I_F$ = 1.3 A, di/dt = 100 A/µs, $T_J$ = 25 °C | | 20 | 40 | ns |
| Body Diode Reverse Recovery Charge | $Q_{rr}$ | | | 20 | 40 | nC |
| Reverse Recovery Fall Time | $t_a$ | | | 16 | | ns |
| Reverse Recovery Rise Time | $t_b$ | | | 4 | | |

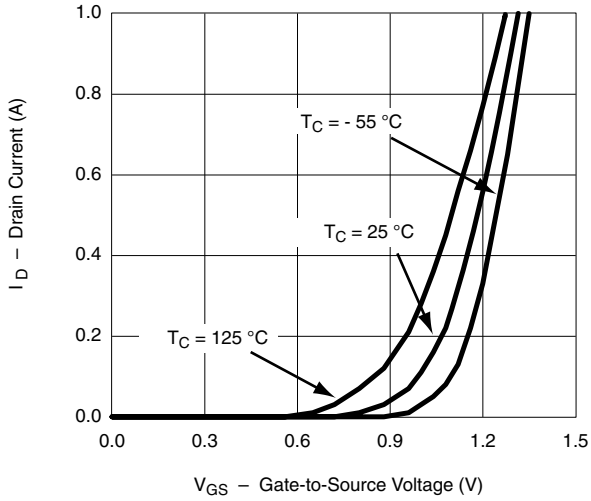
Notes:
a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %.
b. Guaranteed by design, not subject to production testing.

*Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.*

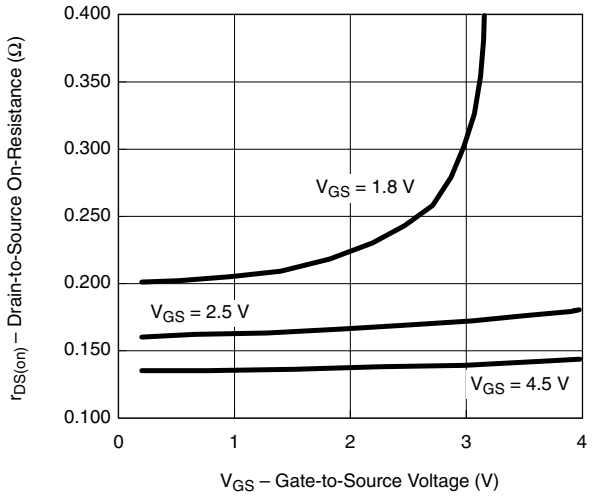
## TYPICAL CHARACTERISTICS 25 °C, unless noted



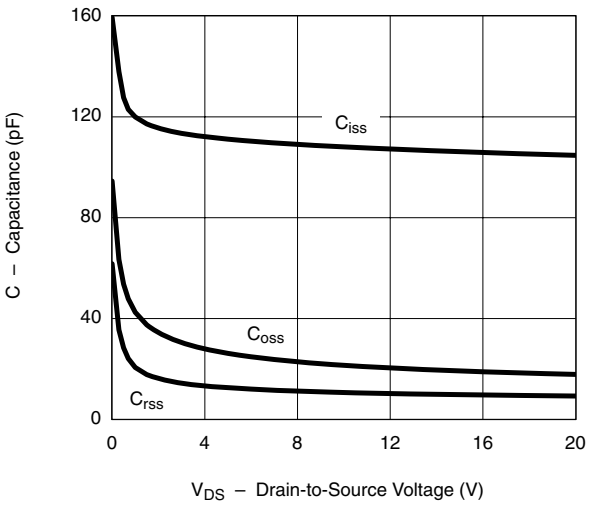

**Output Characteristics**



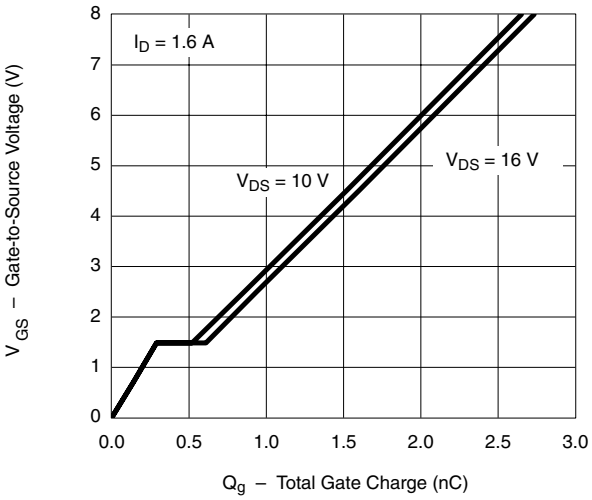

**Transfer Characteristics**



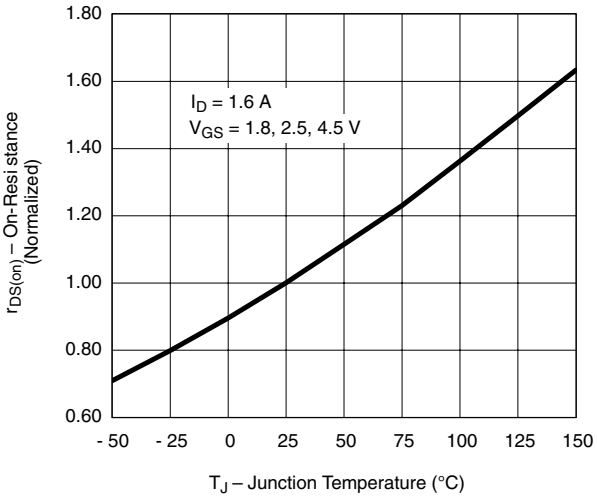

**On-Resistance vs. Drain Current**




**Capacitance**

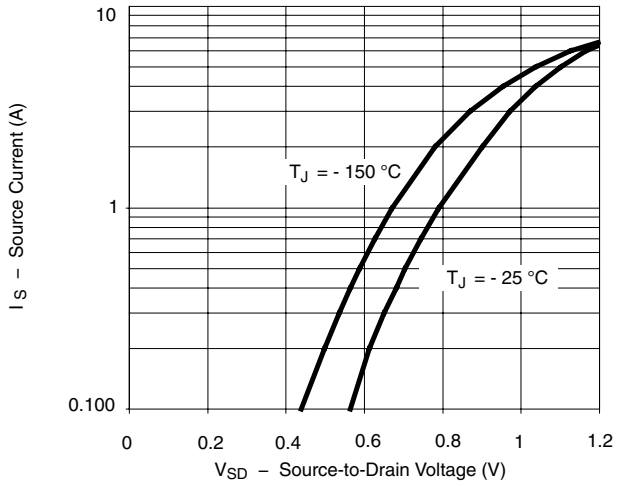



**Gate Charge**

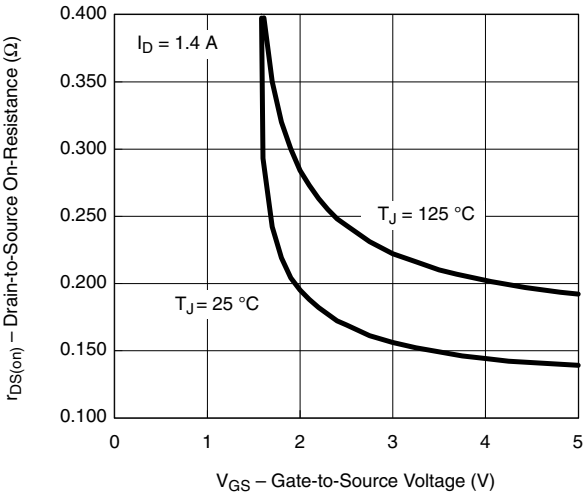



**On-Resistance vs. Junction Temperature**

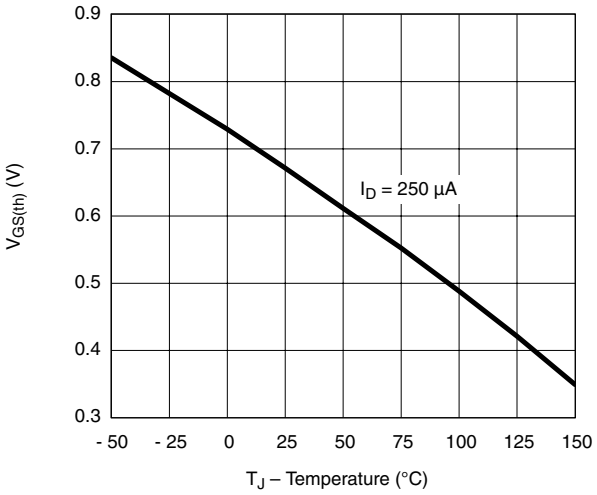
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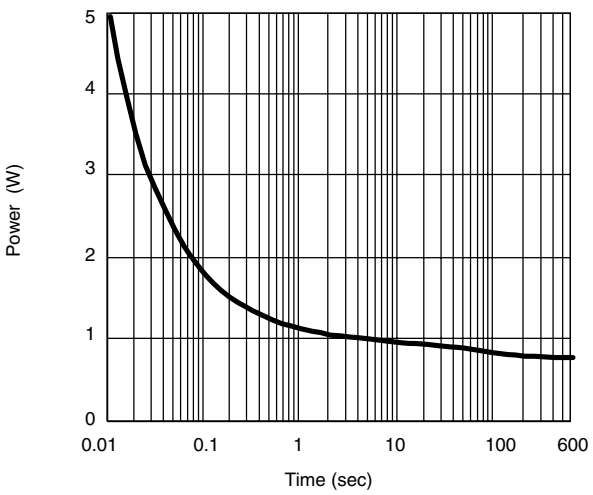

**Forward Diode Voltage**



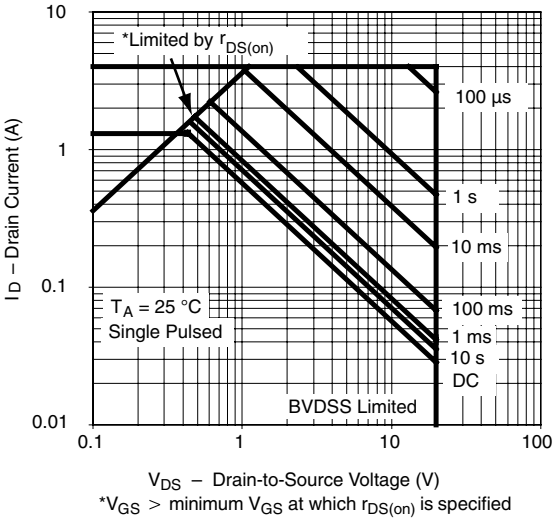

**On-Resistance vs. Gate-Source Voltage**




**Threshold Voltage**



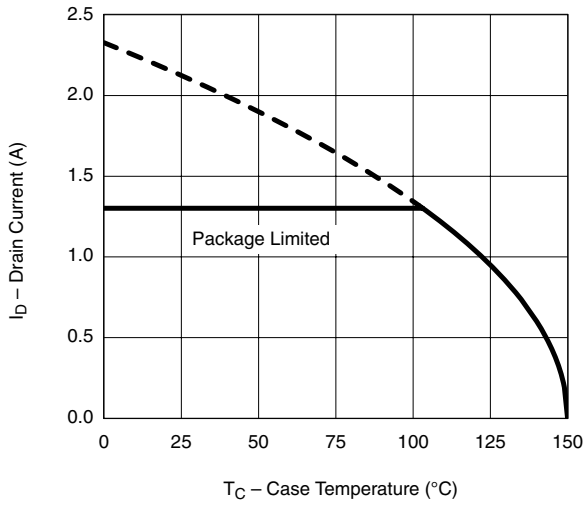

**Single Pulse Power**



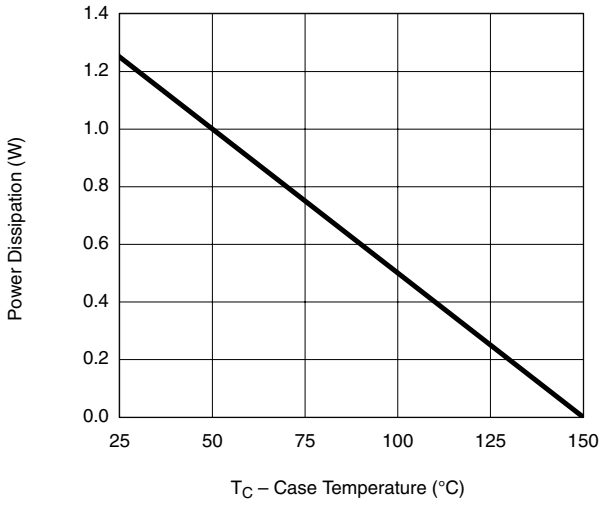

*$V_{GS}$ > minimum $V_{GS}$ at which $r_{DS(on)}$ is specified

**Safe Operating Area, Junction-to-Case**

## TYPICAL CHARACTERISTICS 25 °C, unless noted

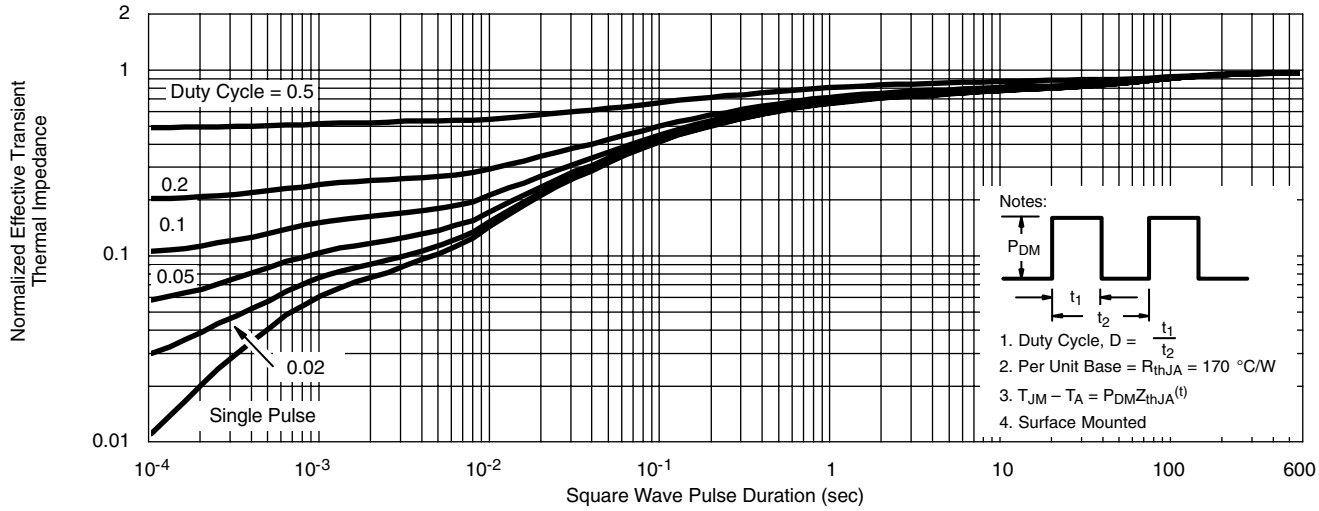



**Current Derating***



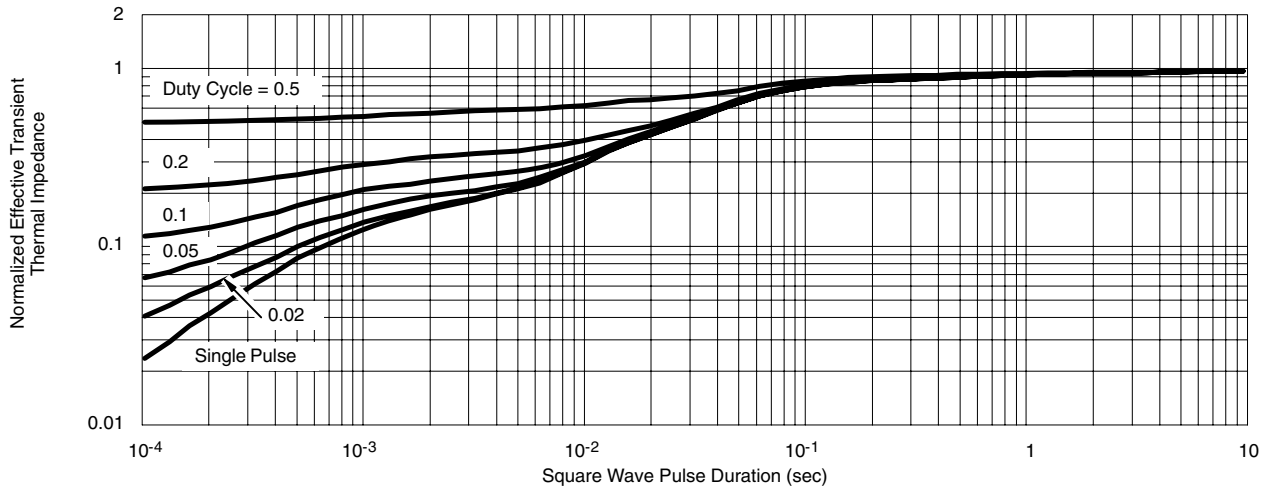

**Power Derating**

*The power dissipation $P_D$ is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.




**Normalized Thermal Transient Impedance, Junction-to-Ambient**

## TYPICAL CHARACTERISTICS 25 °C, unless noted




**Normalized Thermal Transient Impedance, Junction-to-Foot**

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